

140mΩ, 600V, Super Junction N-Channel Power MOSFET
SRC60R140B
General Description

The Sanrise SRC60R140B is a high voltage power MOSFET, fabricated using advanced super junction technology. The resulting device has extremely low on resistance, low gate charge and fast switching time, making it especially suitable for applications which require superior power density and outstanding efficiency.

The SRC60R140B break down voltage is 600V and it has a high rugged avalanche characteristics.

The SRC60R140B is available in TO-220F, TO-220C, TO-263-2 and TO-247 packages.

Features

- Ultra Low $R_{DS(ON)}$ = 140mΩ @ V_{GS} = 10V.
- Ultra Low Gate Charge, Q_g =40.4nC typ.
- Intrinsic Fast-Recovery Body Diode
- Fast switching capability
- Robust design with better EAS performance

Application

- AC/DC Power Supply
- PC Power
- Sever / Telecom
- Solar Inverter

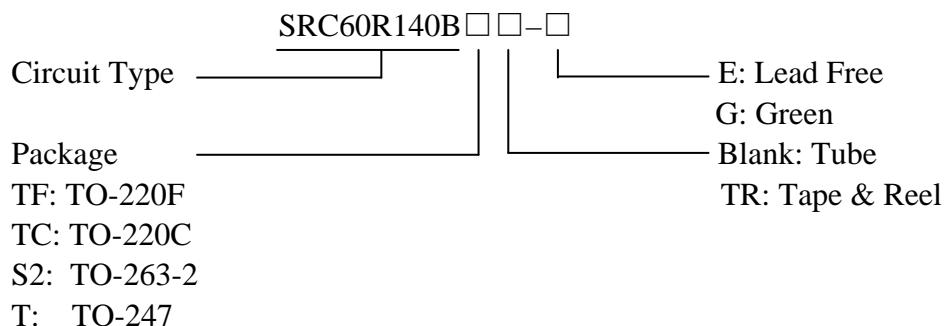
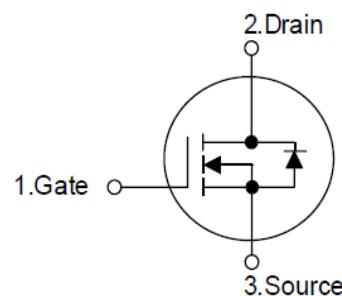
Ordering Information

Symbol


Figure 1 Symbol of SRC60R140B

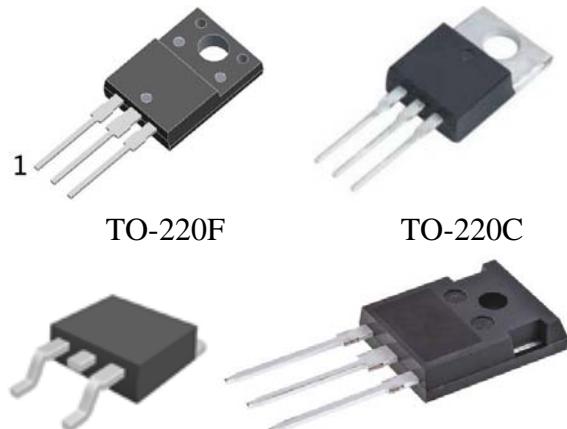
Package Type


Figure 2 Package Types of SRC60R140B

Package	Part Number		Marking ID		Packing Type
	Lead Free	Green	Lead Free	Green	
TO-220F	SRC60R140BTF-E	SRC60R140BTF-G	SRC60R140BTFE	SRC60R140BTFG	Tube
TO-220C	SRC60R140BTC-E	SRC60R140BTC-G	SRC60R140BTCE	SRC60R140BTCG	Tube
TO-263-2	SRC60R140BS2TR-E	SRC60R140BS2TR-G	SRC60R140BS2E	SRC60R140BS2G	Tape & Reel
TO-247	SRC60R140BT-E	SRC60R140BT-G	SRC60R140BTE	SRC60R140BTG	Tube

140mΩ, 600V, Super Junction N-Channel Power MOSFET
SRC60R140B
Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DSS}	600	V
Gate-Source Voltage	V _{GSS}	±30	V
Continuous Drain Current	I _D	25.0	A
T _C =125°C		11.2	
Pulsed Drain Current (Note 2)	I _{DM}	76	A
Avalanche Energy, Single Pulse (Note 3)	E _{AS}	510	mJ
Avalanche Energy, Repetitive (Note 2)	E _{AR}	0.7	mJ
Avalanche Current, Repetitive (Note 2)	I _{AR}	3.6	A
Continuous Diode Forward Current	I _S	25.0	A
Diode Pulse Current	I _{S.PULSE}	76	A
MOSFET dv/dt Ruggedness, V _{DS} <=480V	dv/dt	50	V/ns
Reverse Diode dv/dt, V _{DS} <=480V, I _{SD} <=I _D	dv/dt	50	V/ns
Operating Junction Temperature	T _J	150	°C
Storage Temperature	T _{STG}	-55 to 150	°C
Lead Temperature (Soldering, 10 sec)	T _{LEAD}	260	°C

Note:

1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.
Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating: Pulse width limited by maximum junction temperature
3. I_{AS} = 3.6A, V_{DD} = 60V, R_G = 25Ω, Starting T_J = 25°C

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Electrical Characteristics
 $T_J = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$	600			V
Zero Gate Voltage Drain Current	I_{DSS}	$\text{V}_{\text{DS}}=600\text{V}, \text{V}_{\text{GS}}=0\text{V}$			10	μA
Gate-Body Leakage Current	Forward	I_{GSSF}	$\text{V}_{\text{GS}}=30\text{V}, \text{V}_{\text{DS}}=0\text{V}$		100	nA
	Reverse	I_{GSSR}	$\text{V}_{\text{GS}}=-30\text{V}, \text{V}_{\text{DS}}=0\text{V}$		-1.0	μA
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{TH})}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$	2.3	3.3	4.3	V
Static Drain-Source On-Resistance	$\text{R}_{\text{DS}(\text{ON})}$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=13.0\text{A}$		126	140	$\text{m}\Omega$
Gate Resistance	R_G	f=1MHz, Open Drain		1.7		Ω

Dynamic Characteristics

Input Capacitance	C_{ISS}	$\text{V}_{\text{DS}}=50\text{V}, \text{V}_{\text{GS}}=0\text{V}, \text{f}=1\text{MHz}$		1650		pF
Output Capacitance	C_{OSS}			129.6		
Reverse Transfer Capacitance	C_{RSS}			10.1		
Effective output capacitance, energy related <small>NOTE5</small>	$\text{C}_{\text{O(er)}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=0\ldots 480\text{V}$		76.8		pF
	$\text{C}_{\text{O(tr)}}$			281		
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$\text{V}_{\text{DD}}=400\text{V}, \text{I}_D=13.0\text{A}$ $\text{R}_G=3.4\Omega, \text{V}_{\text{GS}}=10\text{V}$		11		ns
Rise Time	t_r			10		
Turn-off Delay Time	$t_{\text{d}(\text{off})}$			76		
Fall Time	t_f			8		

Gate Charge Characteristics

Gate to Source Charge	Q_{gs}	$\text{V}_{\text{DD}}=480\text{V}, \text{I}_D=13.0\text{A}$ $\text{V}_{\text{GS}}=0\text{ to }10\text{V}$		10.8		nC
Gate to Drain Charge	Q_{gd}			13.9		
Gate Charge Total	Q_g			40.4		
Gate Plateau Voltage	$\text{V}_{\text{plateau}}$			5.4		V

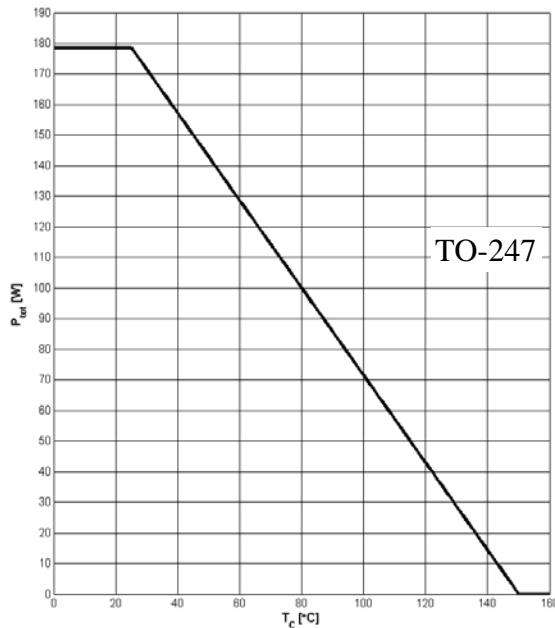
Reverse Diode Characteristics

Drain-Source Diode Forward Voltage	V_{SD}	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_{\text{SD}}=13.0\text{A}$		0.90	1.1	V
Reverse Recovery Time	t_{rr}	$\text{V}_R=400\text{V}, \text{I}_F=13.0\text{A}$ $d\text{I}_F/dt=100.0\text{A}/\mu\text{s}$		124		ns
Reverse Recovery Charge	Q_{rr}			0.59		uC
Peak Reverse Recovery Current	I_{rrm}			9.5		A

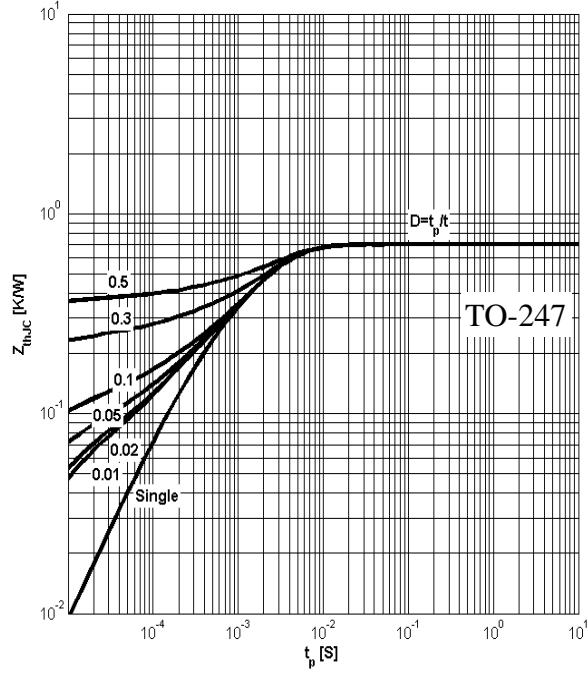
Note:

 5. $\text{C}_{\text{O(er)}}$ is a fixed capacitance that gives the same stored energy as C_{OSS} while V_{DS} is rising from 0 to 480V

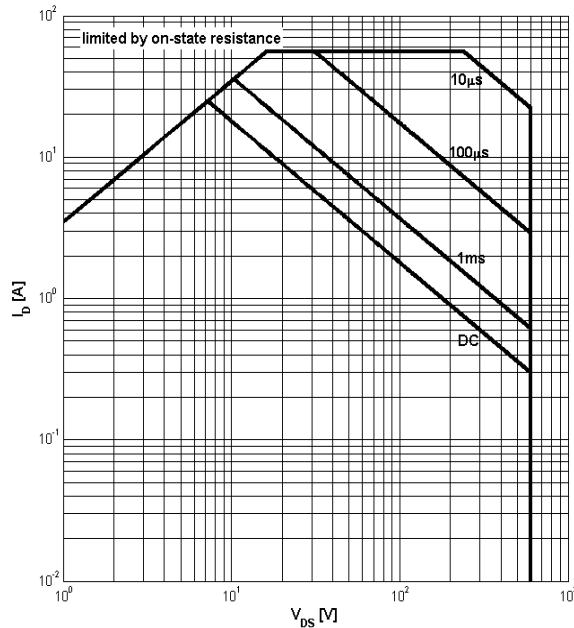
 6. $\text{C}_{\text{O(tr)}}$ is a fixed capacitance that gives the same charging time as C_{OSS} while V_{DS} is rising from 0 to 480 V

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Typical Performance Characteristics
Figure 3: Power Dissipation


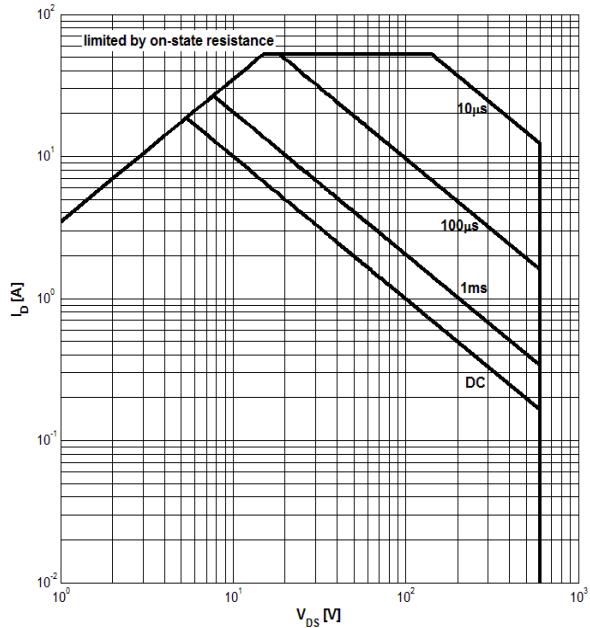
$$P_{tot} = f(T_c)$$

Figure 4: Max. Transient Thermal Impedance


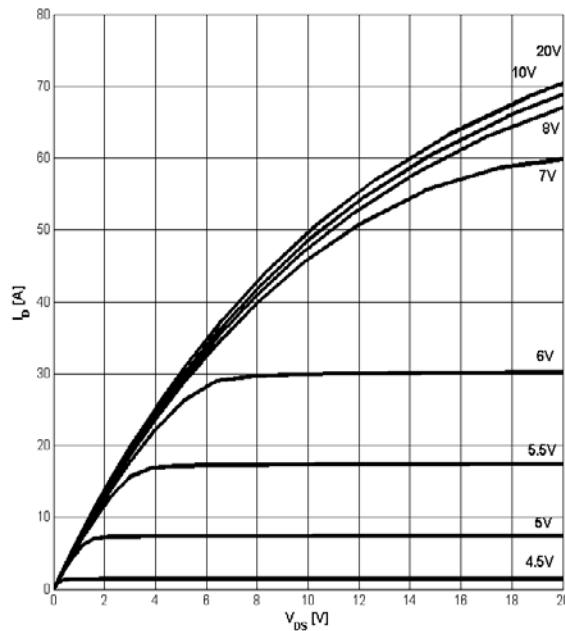
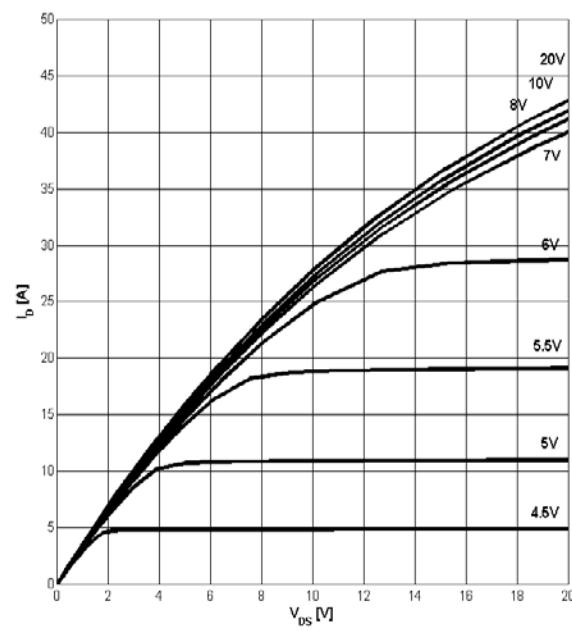
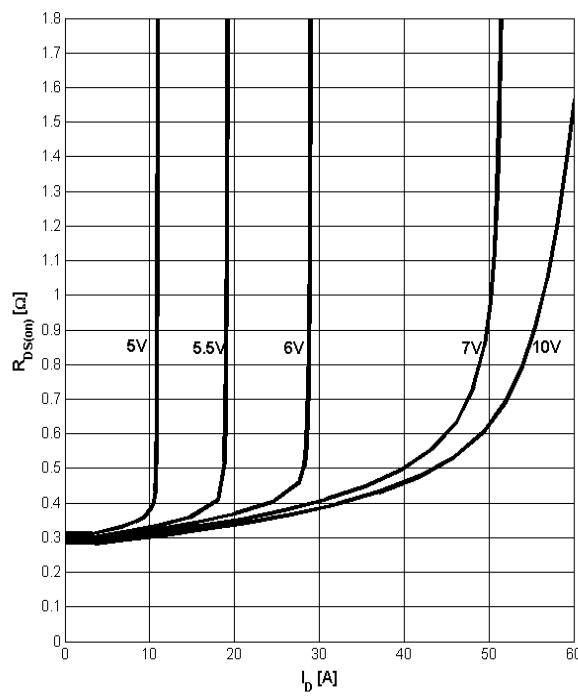
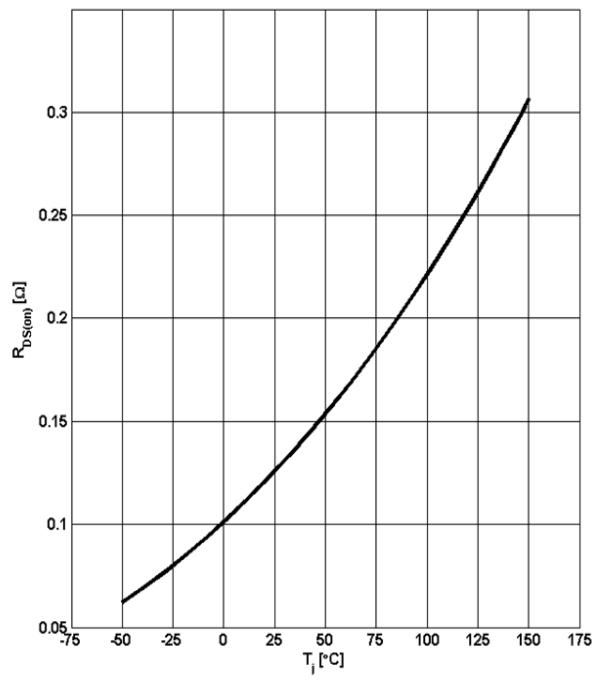
$$Z_{(thJC)} = f(t_p); \text{ parameter: } D = t_p/T$$

Figure 5: Safe Operating Area


$$I_D = f(V_{DS}); T_c = 25^\circ\text{C}; V_{GS} > 7\text{V}; \text{ parameter } t_p$$

Figure 6: Safe Operating Area


$$I_D = f(V_{DS}); T_c = 80^\circ\text{C}; V_{GS} > 7\text{V}; \text{ parameter } t_p$$

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Figure 7: Typ. Output Characteristics

 $I_D = f(V_{DS})$; $T_j = 25^\circ\text{C}$; parameter: V_{GS}
Figure 8: Typ. Output Characteristics

 $I_D = f(V_{DS})$; $T_j = 125^\circ\text{C}$; parameter: V_{GS}
Figure 9: Typ. Drain-Source On-State Resistance

 $R_{DS(ON)} = f(I_D)$; $T_j = 125^\circ\text{C}$; parameter: V_{GS}
Figure 10: Typ. Drain-Source On-State Resistance

 $R_{DS(ON)} = f(T_j)$; $I_D = 13\text{A}$; $V_{GS} = 10\text{V}$

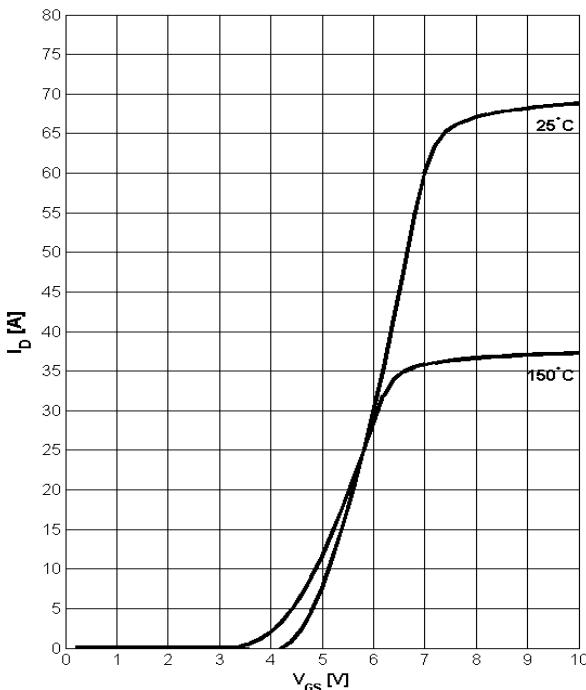
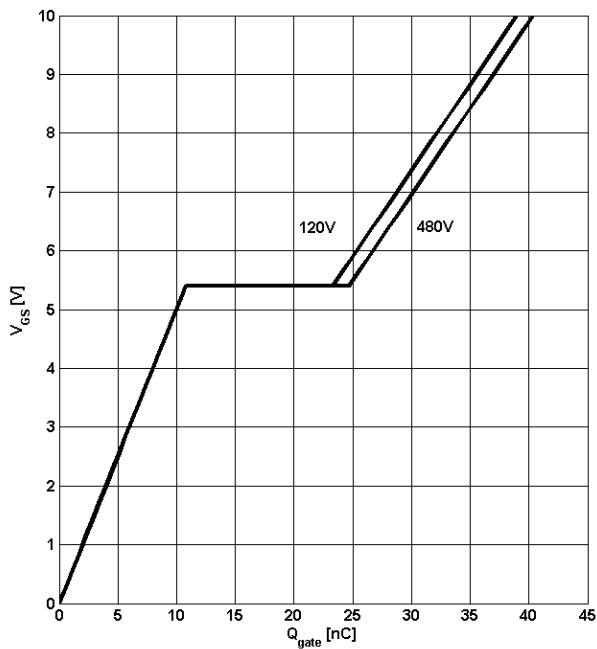
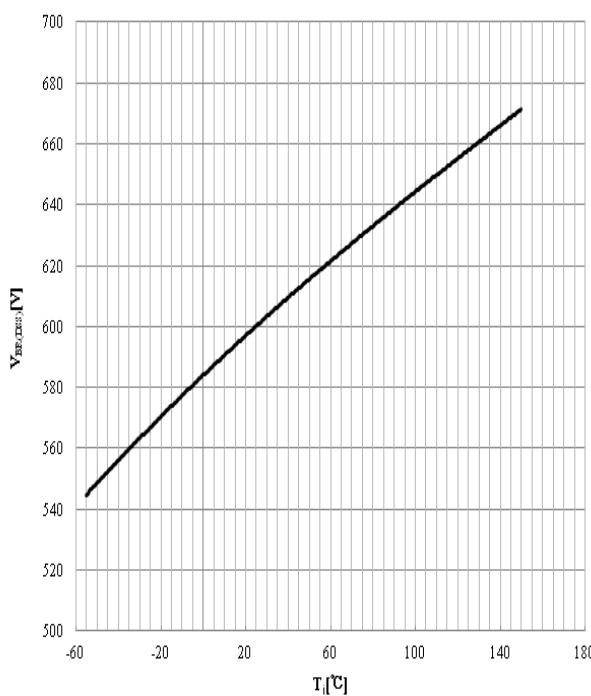
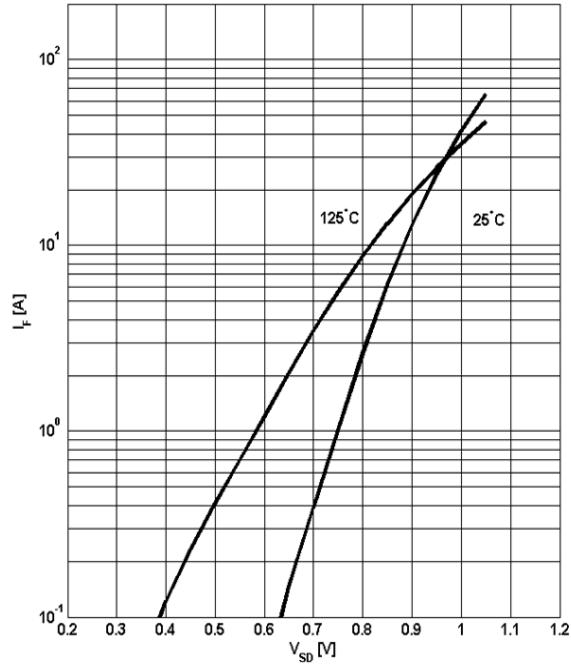
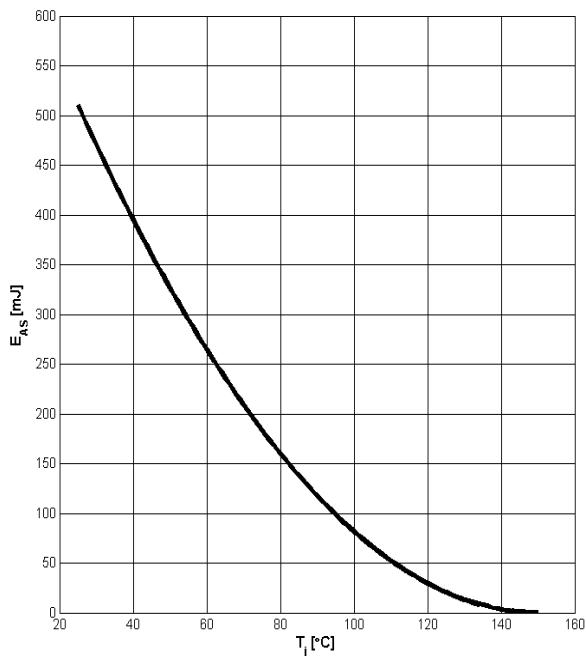
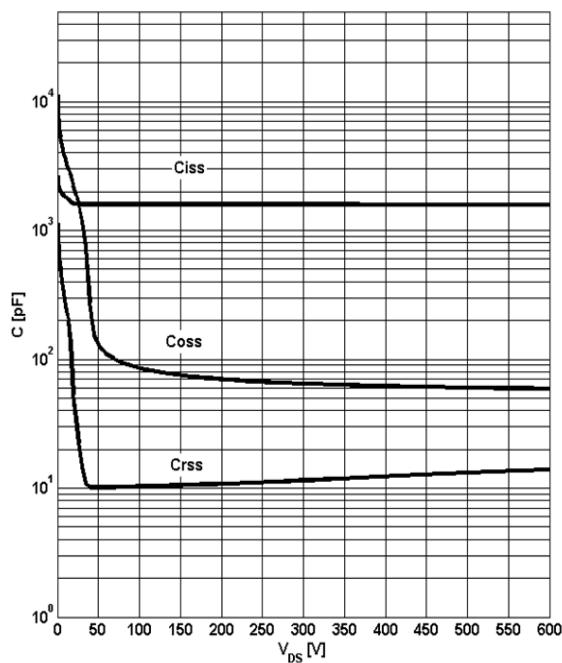
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Figure 11: Typ. Transfer Characteristics

 $I_D = f(V_{GS})$; $V_{DS} = 20\text{V}$
Figure 12: Typ. Gate Charge

 $V_{GS} = f(Q_{gate})$, $I_D = 13\text{A}$ pulsed

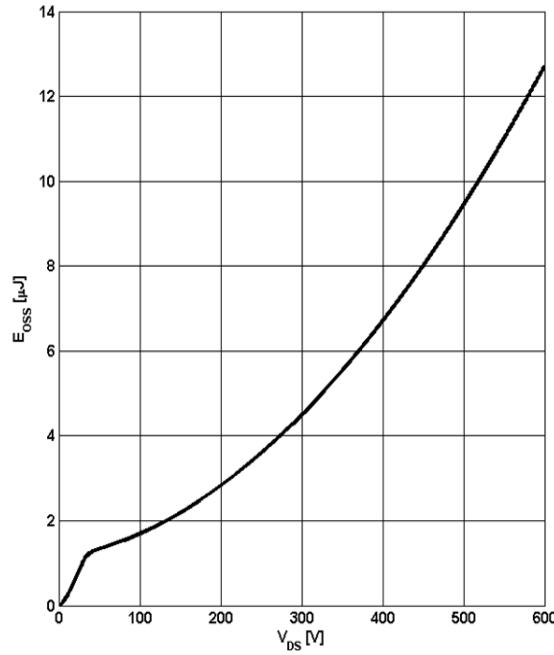
Figure 13: Drain-Source Breakdown Voltage

 $V_{BR(DSS)} = f(T_j)$; $I_D = 1\text{mA}$
Figure 14: Forward Characteristics of Reverse Diode

 $I_F = f(V_{SD})$; parameter: T_j

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Figure 15: Avalanche Energy


$$E_{AS}=f(T_j); I_D=3.6A; V_{DD}=60V$$

Figure 16: Typ. Capacitances


$$C=f(V_{DS}); V_{GS}=0; f=1MHz$$

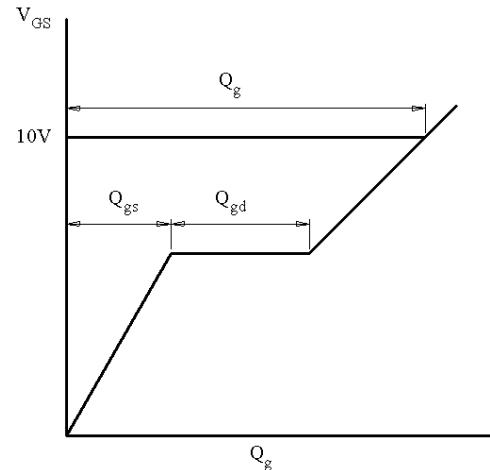
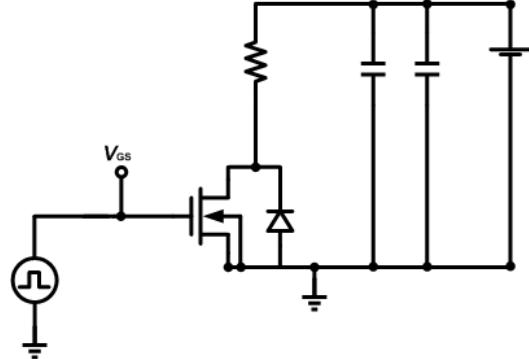
Figure 17: C_{oss} Stored Energy


$$E_{oss}=f(V_{DS})$$

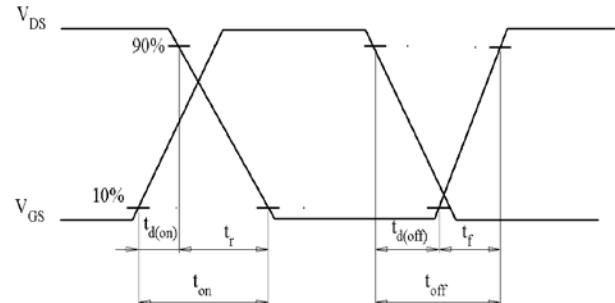
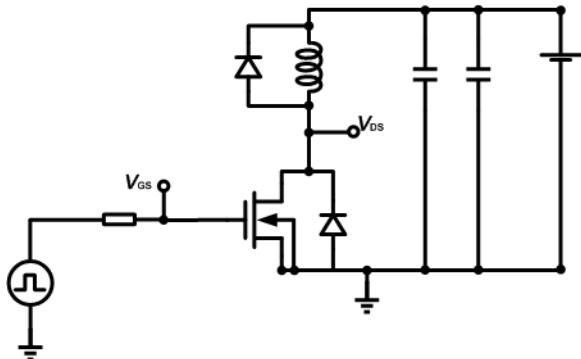
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Test Circuits

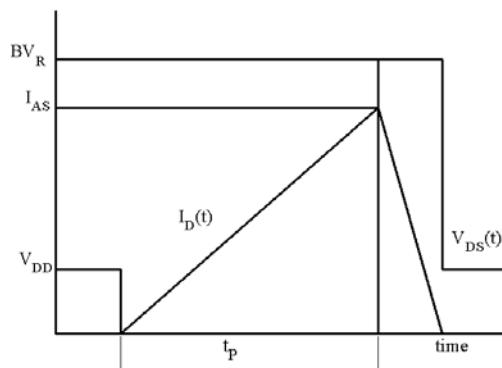
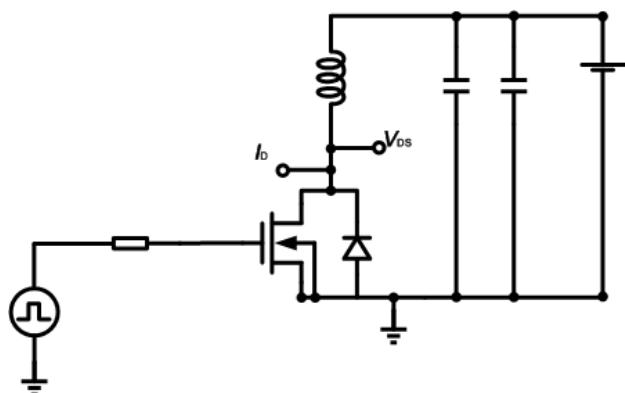
1. Gate Charge Test Circuit & Waveform



2. Switch Time Test Circuit

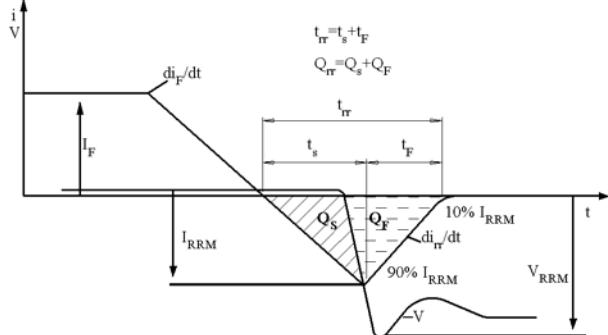
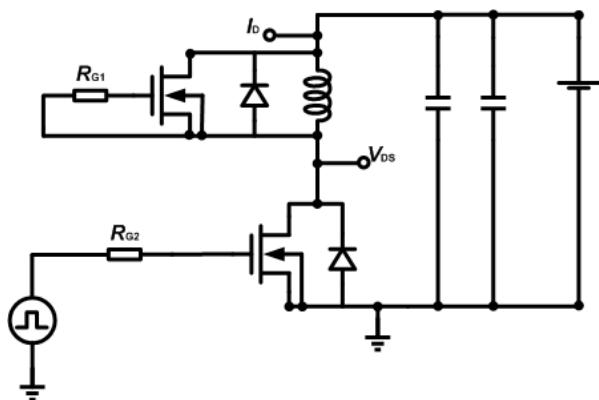


3. Unclaimed Inductive Switching Test Circuit & Waveforms



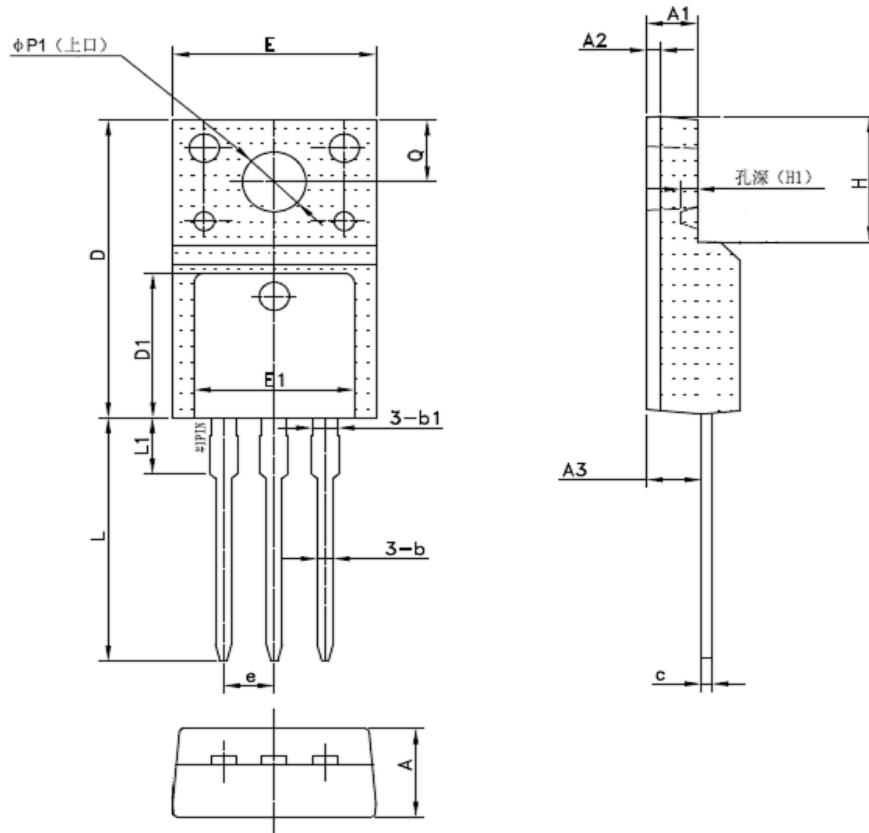
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4. Test Circuit and Waveform for Diode Characteristics

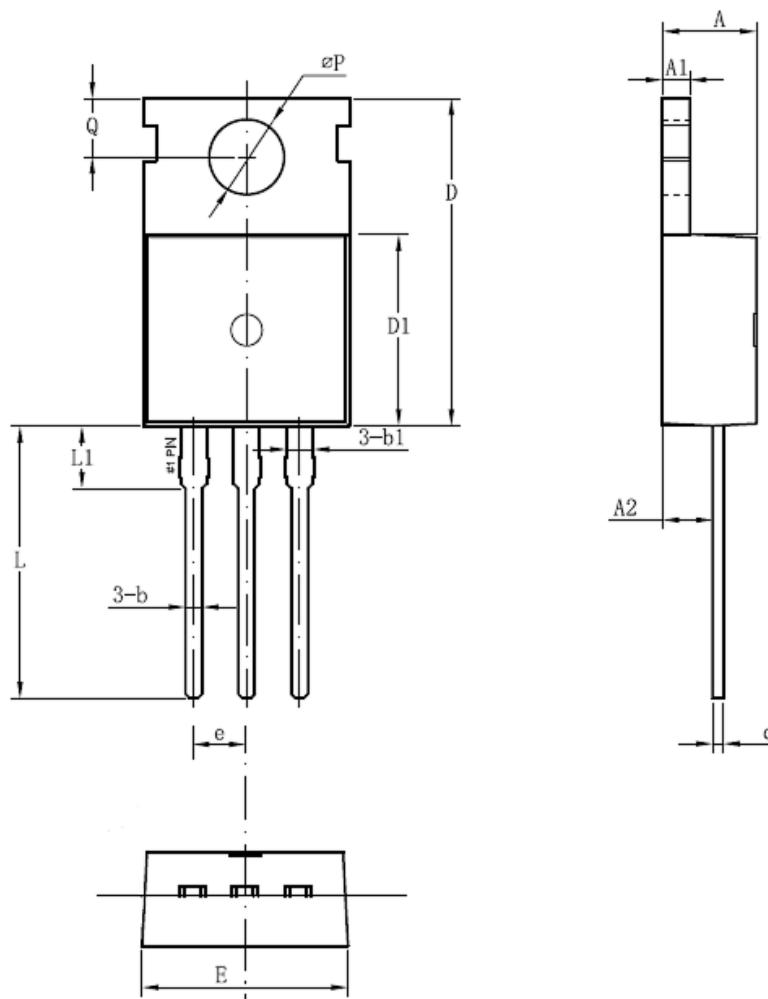


140mΩ, 600V, Super Junction N-Channel Power MOSFET
SRC60R140B

Mechanical Dimensions

TO-220F
Unit: mm


Symbol	Dimensions(mm)		
	Min.	Typ.	Max.
A	4.30	4.70	4.90
A1	2.34	2.54	2.90
A2	-	0.70	-
A3	2.56	2.76	2.96
b	0.55	-	0.95
b1	-	1.28	-
c	0.42	0.50	0.70
D	14.70	-	16.07
D1	-	7.70	-
E	9.96	10.16	10.36
E1	-	8.00	-
e	2.54(BSC)		
H	-	6.70	-
(H1)	-	(0.81)	-
L	12.48	12.98	13.50
L1	-	2.93	-
ΦP1	-	3.18	-
Q	2.90	3.30	3.50

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Mechanical Dimensions (Continued)
TO-220C
Unit: mm


Symbol	Dimensions(mm)		
	Min.	Typ.	Max.
A	4.30	4.50	4.70
A1	1.20	1.30	1.40
A2	2.20	2.40	2.60
b	0.70	0.80	0.95
b1	-	1.27	-
c	0.40	0.50	0.65
D	15.20	15.70	16.20
D1	9.00	9.20	9.40
E	9.70	10.00	10.20
e	2.54(BSC)		
L	12.60	13.08	13.60
L1	-	3.00	-
ΦP	3.50	3.60	3.80
Q	2.60	2.80	3.00

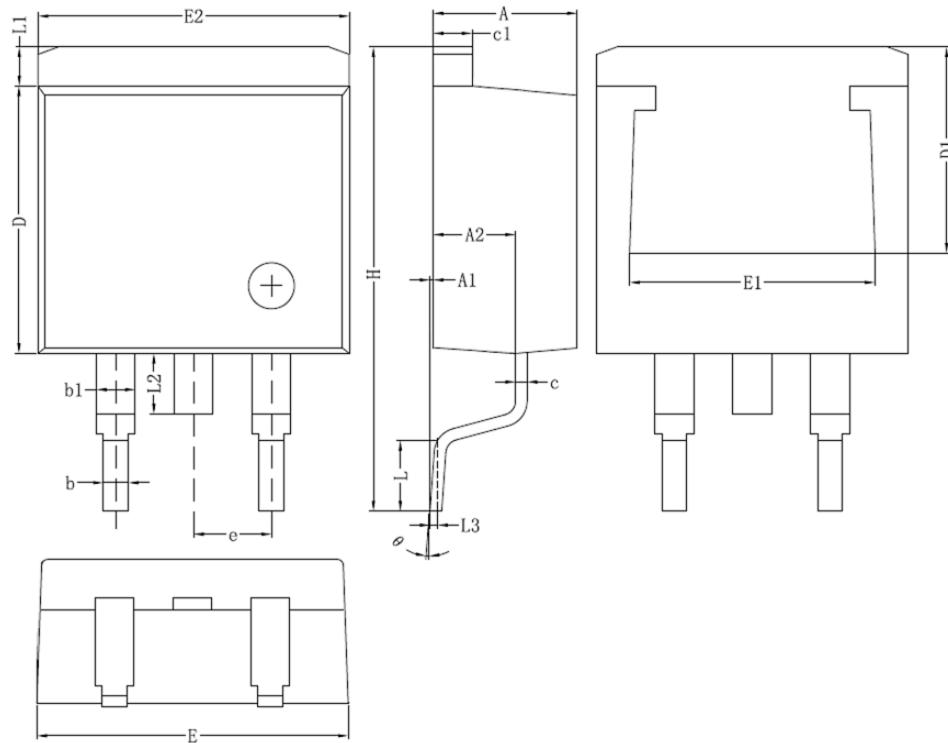
140mΩ, 600V, Super Junction N-Channel Power MOSFET

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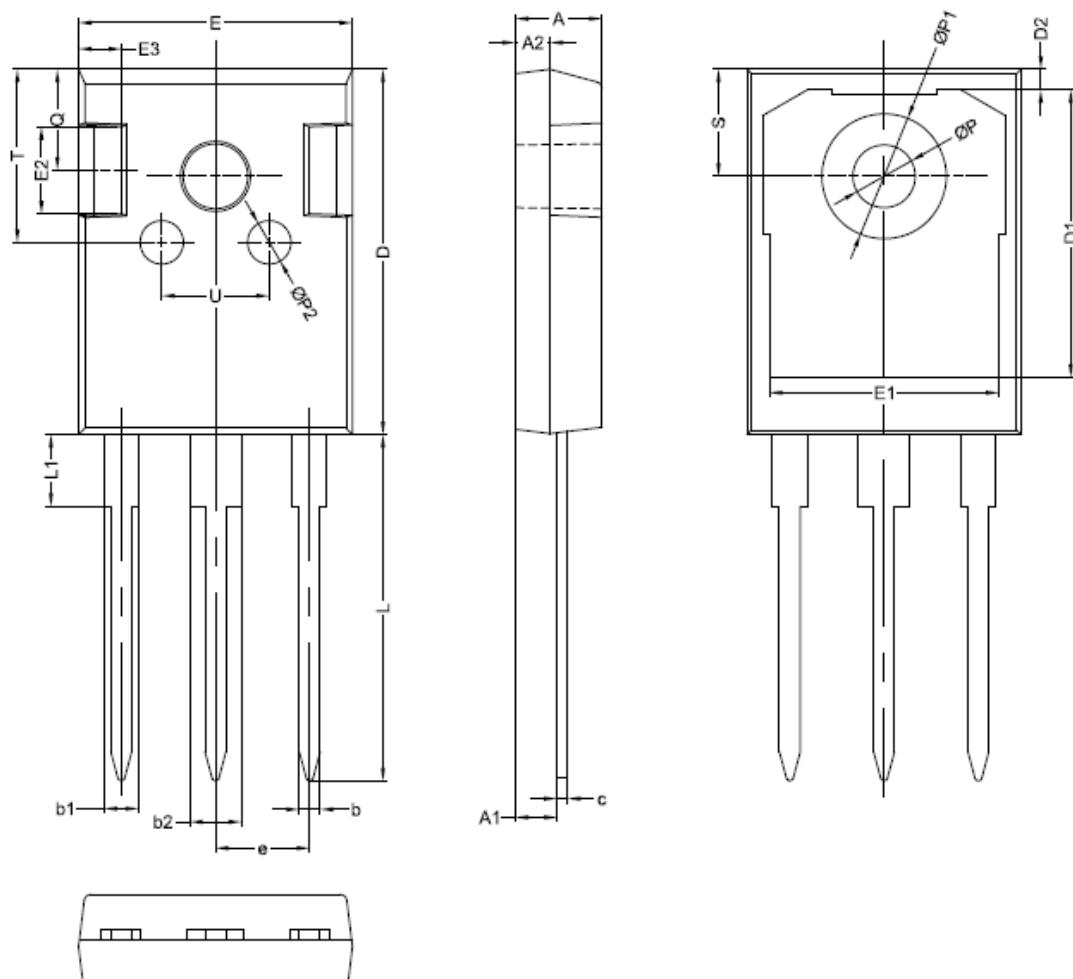
Mechanical Dimensions (Continued)

TO-263-2

Unit: mm



Symbol	Dimensions(mm)		
	Min.	Typ.	Max.
A	4.30	4.60	4.85
A1	0.00	0.10	0.25
A2	2.59	2.69	2.89
b	0.70	0.81	0.96
b1	-	1.27	-
c	0.36	0.40	0.61
c1	1.15	1.27	1.40
D	8.55	-	9.40
D1	6.40	-	-
E	9.80	10.10	10.31
E1	7.60	-	-
E2	9.80	10.00	10.20
e	2.54(BSC)		
H	14.70	15.20	16.00
L	2.00	2.30	2.84
L1	1.00	1.27	1.40
L2	-	-	2.20
L3	-	0.25	-
θ	0°	-	8°

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Mechanical Dimensions (Continued)
TO-247
Unit: mm


Symbol	Dimensions(mm)			Symbol	Dimensions(mm)		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	4.80	5.00	5.20	E2	-	5.00	-
A1	2.21	2.41	2.61	E3	-	2.50	-
A2	1.90	2.00	2.10	e	5.44(BSC)		
b	1.10	1.20	1.35	L	19.42	19.92	20.42
b1	-	2.00	-	L1	-	4.13	-
b2	-	3.00	-	P	3.50	3.60	3.70
c	0.55	0.60	0.75	P1	-	-	7.40
D	20.80	21.00	21.20	P2	-	2.50	-
D1	-	16.55	-	Q	-	5.80	-
D2	-	1.20	-	S	6.05	6.15	6.25
E	15.60	15.80	16.00	T	-	10.00	-
E1	-	13.30	-	U	-	6.20	-



Sanrise Technology Limited Company

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